# Himax Automotive TDDI Obtains Dual World-Class Quality and Global Safety Certifications Reinforcing Himax's Leadership in the Automotive Display IC Market

## *DEKRA ASPICE CL2 and SGS ISO 26262 ASIL-B Certifications Affirm Rigorous Automotive IC Development Processes and Uncompromising Standards of Quality and Safety*

**TAINAN Taiwan – Sep. 30, 2025** – Himax Technologies, Inc. (Nasdaq: HIMX) ("Himax" or "Company"), a leading supplier and fabless manufacturer of display drivers and other semiconductor products, today announced that its automotive TDDI has successfully obtained dual international certifications: the Automotive SPICE® (ASPICE) v3.1 CL2 certification from DEKRA, and the SGS ISO 26262 ASIL B Ready Functional Safety certification. By aligning with world-class safety and quality standards while leveraging its advanced technologies, Himax is driving the evolution of smart cockpits delivering reliable and competitive solutions to global automakers and Tier 1 suppliers.

ASPICE (Automotive System/Software Process Improvement and Capability Determination) is a widely adopted maturity model for software and system development processes in the global automotive industry. It ensures consistency, reliability, and traceability throughout the development of automotive software and electronic components. With the rapid growth of electrification and autonomous driving, ASPICE has become a critical quality and process benchmark across the automotive supply chain.

In addition, Himax has earned the SGS ISO 26262 ASIL B Ready certification, a globally recognized benchmark for automotive functional safety. This certification ensures that automotive electronic and electrical systems uphold the highest levels of safety and reliability throughout design, development, and deployment. SGS ISO 26262 validates that Himax's automotive IC product development processes fully comply with the stringent standards of global automakers, further reinforcing its position as a trusted partner for automakers and Tier 1 suppliers around the world.

As smart cockpits continue to evolve, displays have emerged as a core component, fueling market growth. With nearly two decades of expertise in automotive displays, Himax has built a comprehensive, industry-leading portfolio of display IC solutions spanning LCD to OLED and holds a dominant global market share across multiple automotive panel IC segments. Achieving DEKRA's ASPICE CL2 and SGS ISO 26262 ASIL-B certifications not only highlights Himax's strength in both software and hardware development for automotive IC products, but also underscores the Company's unwavering commitment to safety, reliability, and performance, laying a solid foundation for validation with global automakers and Tier 1 suppliers.

"The dual certifications of ASPICE CL2 and ISO 26262 ASIL-B affirm the rigorous processes behind Himax's automotive display IC development. We remain dedicated to serving the global market with uncompromising standards of quality and safety, while continuously driving upgrades and innovation in the smart cockpit" said Ming-Cheng Chiu, Executive Vice President of Touch and Display Business Unit at Himax.

**About Himax Technologies, Inc.**

Himax Technologies, Inc. (NASDAQ: HIMX) is a leading global fabless semiconductor solution provider dedicated to display imaging processing technologies. The Company's display driver ICs and timing controllers have been adopted at scale across multiple industries worldwide including TVs, PC monitors, laptops, mobile phones, tablets, automotive, ePaper devices, industrial displays, among others. As the global market share leader in automotive display technology, the Company offers innovative and comprehensive automotive IC solutions, including traditional driver ICs, advanced in-cell Touch and Display Driver Integration (TDDI), local dimming timing controllers (Local Dimming Tcon), Large Touch and Display Driver Integration (LTDI) and OLED display technologies. Himax is also a pioneer in tinyML visual-AI and optical technology related fields. The Company's industry-leading WiseEye™ Ultralow Power AI Sensing technology which incorporates Himax proprietary ultralow power AI processor, always-on CMOS image sensor, and CNN-based AI algorithm has been widely deployed in consumer electronics and AIoT related applications. Himax optics technologies, such as diffractive wafer level optics, LCoS microdisplays and 3D sensing solutions, are critical for facilitating emerging AR/VR/metaverse technologies. Additionally, Himax designs and provides touch controllers, OLED ICs, LED ICs, EPD ICs, power management ICs, and CMOS image sensors for diverse display application coverage. Founded in 2001 and headquartered in Tainan, Taiwan, Himax currently employs around 2,200 people from three Taiwan-based offices in Tainan, Hsinchu and Taipei and country offices in China, Korea, Japan, Germany, and the US. Himax has 2,609 patents granted and 370 patents pending approval worldwide as of June 30, 2025.

http://www.himax.com.tw

**Forward Looking Statements**

Factors that could cause actual events or results to differ materially from those described in this conference call include, but are not limited to, the effect of the Covid-19 pandemic on the Company's business; general business and economic conditions and the state of the semiconductor industry; market acceptance and competitiveness of the driver and non-driver products developed by the Company; demand for end-use applications products; reliance on a small group of principal customers; the uncertainty of continued success in technological innovations; our ability to develop and protect our intellectual property; pricing pressures including declines in average selling prices; changes in customer order patterns; changes in estimated full-year effective tax rate; shortage in supply of key components; changes in environmental laws and regulations; changes in export license regulated by Export Administration Regulations (EAR); exchange rate fluctuations; regulatory approvals for further investments in our subsidiaries; our ability to collect accounts receivable and manage inventory and other risks described from time to time in the Company's SEC filings, including those risks identified in the section entitled "Risk Factors" in its Form 20-F for the year ended December 31, 2024 filed with the SEC, as may be amended.

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